

03-27-01

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**NON-PROVISIONAL APPLICATION FOR U. S. PATENT UNDER 37 CFR 1.53(b)
TRANSMITTAL FORM**

Attorney Docket No. TI-30589

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

Transmitted herewith for filing is the
patent application of:

Inventor(s): **Gonzalo Amador**
Roger J. Stierman

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EL690653937US Date of Deposit: **March 23,**
2001 I hereby certify that this paper is being
deposited with the U.S. Postal Service Express
Mail Post Office to Addressee Service under 37
CFR 1.10 on the date shown above and is
addressed to the Assistant Commissioner for
Patents, Washington, D.C. 20231.

Nancy Thornton
Nancy Thornton

For: **Fixture and Method for Uniform Electroless Metal Deposition on Integrated Circuit Bond Pads**

Enclosed are:

- 2 Sheets of formal drawings and 18 pages of Specification (including Abstract)
- X A Declaration/Power of Attorney
- X Assignment with form PTO 1595

Please amend the specification by inserting before the first line the sentence:

This application claims priority under 35 USC § 119 based upon **Provisional Patent**
Application number 60/193,615, filed 03/31/2000.

FEE CALCULATION					FEE
	NUMBER		NUMBER EXTRA	RATE	BASIC FEE \$ 710.00
Total Claims	11	-20 =	0	X \$22 =	\$0.00
Independent Claims	2	- 3 =	0	X \$82 =	\$0.00
Total Filing Fee					\$710.00

Please charge **Deposit Account No. 20-0668** in the amount of the Total Fees set forth. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 20-0668. **This form is submitted in triplicate.**

All correspondence related to this application may be addressed to the undersigned at Navarro IP Law Group, P.C. 801 E. Campbell Rd. Suite 655, Richardson, TX 75081.

Date: **March 23, 2001**

Gary C. Hongycutt
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